# **Dual General Purpose Transistors**

# **NPN Duals**

These transistors are designed for general purpose amplifier applications. They are housed in the SOT-363/SC-88 which is designed for low power surface mount applications.

• Device Marking:

BC846BDW1T1 = 1B

BC847BDW1T1 = 1F

BC848CDW1T1 = 1L

#### **Features**

• Pb-Free Package is Available

#### **MAXIMUM RATINGS**

Rating	Symbol	BC846	BC847	BC848	Unit
Collector-Emitter Voltage	V <sub>CEO</sub>	65	45	30	V
Collector-Base Voltage	V <sub>CBO</sub>	80	50	30	V
Emitter-Base Voltage	V <sub>EBO</sub>	6.0	6.0	5.0	V
Collector Current – Continuous	Ic	100	100	100	mAdc

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

#### THERMAL CHARACTERISTICS

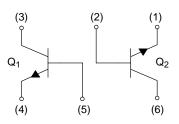
Characteristic	Symbol	Max	Unit
Total Device Dissipation Per Device FR-5 Board (Note 1) T <sub>A</sub> = 25°C	P <sub>D</sub>	380 250	mW
Derate Above 25°C		3.0	mW/°C
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	328	°C/W
Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C

1.  $FR-5 = 1.0 \times 0.75 \times 0.062$  in



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#### DIAGRAM MARKING



SOT-363 CASE 419B STYLE 1



1x = Specific Device Code

x = B, F, Lm = Date Code

#### ORDERING INFORMATION

Device	Package	Shipping <sup>†</sup>
BC846BDW1T1	SOT-363	3000 Units/Reel
BC847BDW1T1	SOT-363	3000 Units/Reel
BC847BDW1T1G	SOT-363 (Pb-Free)	3000 Units/Reel
BC848CDW1T1	SOT-363	3000 Units/Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

# $\textbf{ELECTRICAL CHARACTERISTICS} \ (T_A = 25^{\circ}C \ unless \ otherwise \ noted)$

Characteristic	Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS		·		ı	
Collector – Emitter Breakdown Voltage (I <sub>C</sub> = 10 mA) BC846 BC847 BC848	V <sub>(BR)</sub> CEO	65 45 30	- - -	- - -	V
Collector – Emitter Breakdown Voltage (I <sub>C</sub> = 10 μA, V <sub>EB</sub> = 0) BC846 BC847 BC848	V <sub>(BR)</sub> CES	80 50 30	- - -	- - -	V
Collector – Base Breakdown Voltage (I <sub>C</sub> = 10 μA)  BC846 BC847 BC848	V <sub>(BR)</sub> CBO	80 50 30	- - -	- - -	V
Emitter – Base Breakdown Voltage (I <sub>E</sub> = 1.0 μA)  BC846 BC847 BC848	V <sub>(BR)EBO</sub>	6.0 6.0 5.0	- - -	- - -	V
Collector Cutoff Current ( $V_{CB} = 30 \text{ V}$ ) ( $V_{CB} = 30 \text{ V}$ , $T_A = 150^{\circ}\text{C}$ )	I <sub>CBO</sub>	- -	- -	15 5.0	nA μA
ON CHARACTERISTICS	ı	Т	T	T	T
DC Current Gain $(I_C = 10 \; \mu\text{A, V}_{CE} = 5.0 \; \text{V}) \\ BC846B, BC847B} \\ BC848C$	h <sub>FE</sub>	- -	150 270	- -	_
$(I_C = 2.0 \text{ mA}, V_{CE} = 5.0 \text{ V})$ BC846B, BC847B BC848C		200 420	290 520	450 800	
Collector – Emitter Saturation Voltage ( $I_C$ = 10 mA, $I_B$ = 0.5 mA) ( $I_C$ = 100 mA, $I_B$ = 5.0 mA)	V <sub>CE(sat)</sub>		_ _	0.25 0.6	V
Base – Emitter Saturation Voltage ( $I_C$ = 10 mA, $I_B$ = 0.5 mA) ( $I_C$ = 100 mA, $I_B$ = 5.0 mA)	V <sub>BE(sat)</sub>	-	0.7 0.9		V
Base – Emitter Voltage ( $I_C$ = 2.0 mA, $V_{CE}$ = 5.0 V) ( $I_C$ = 10 mA, $V_{CE}$ = 5.0 V)	V <sub>BE(on)</sub>	580 -	660 -	700 770	mV
SMALL-SIGNAL CHARACTERISTICS					
Current – Gain – Bandwidth Product (I <sub>C</sub> = 10 mA, V <sub>CE</sub> = 5.0 Vdc, f = 100 MHz)	f <sub>T</sub>	100	_	_	MHz
Output Capacitance (V <sub>CB</sub> = 10 V, f = 1.0 MHz)	C <sub>obo</sub>	_	-	4.5	pF
Noise Figure (I <sub>C</sub> = 0.2 mA, V <sub>CE</sub> = 5.0 Vdc, R <sub>S</sub> = 2.0 k $\Omega$ ,f = 1.0 kHz, BW = 200 Hz)	NF	_	_	10	dB

#### **TYPICAL CHARACTERISTICS - BC847 & BC848**

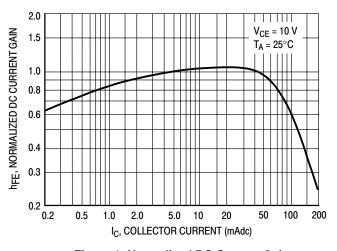


Figure 1. Normalized DC Current Gain

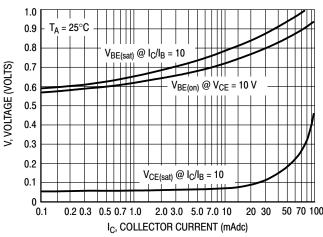


Figure 2. "Saturation" and "On" Voltages

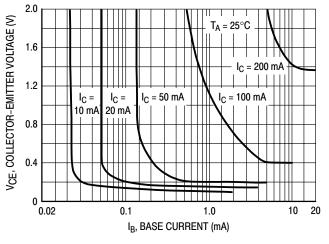


Figure 3. Collector Saturation Region

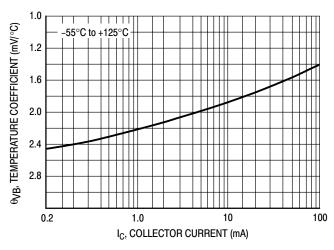


Figure 4. Base-Emitter Temperature Coefficient

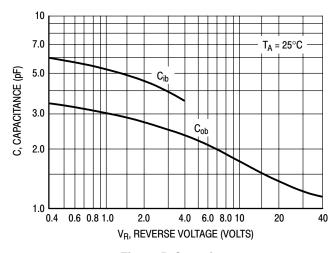


Figure 5. Capacitances

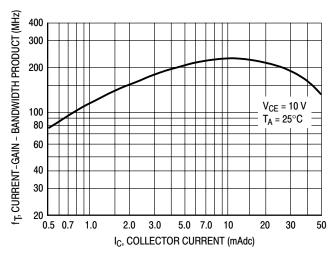


Figure 6. Current-Gain - Bandwidth Product

#### **TYPICAL CHARACTERISTICS - BC846**

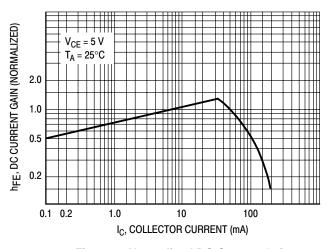


Figure 7. Normalized DC Current Gain

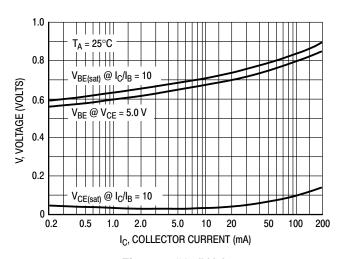


Figure 8. "On" Voltage

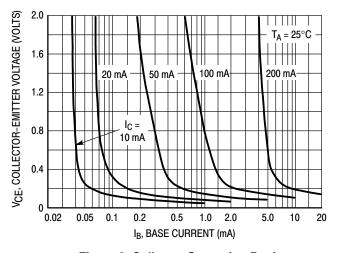


Figure 9. Collector Saturation Region

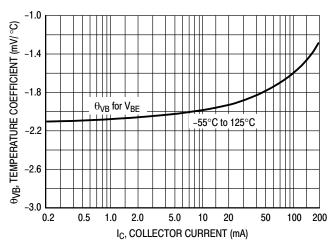


Figure 10. Base-Emitter Temperature Coefficient

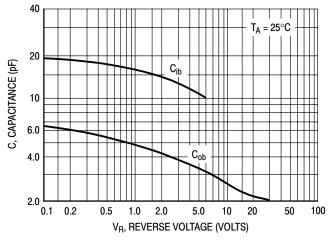


Figure 11. Capacitance

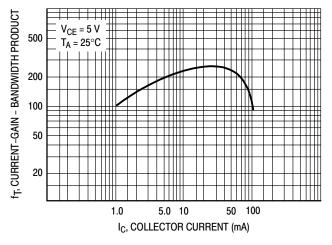


Figure 12. Current-Gain - Bandwidth Product

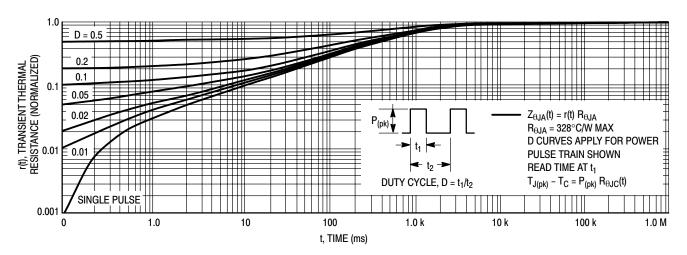


Figure 13. Thermal Response

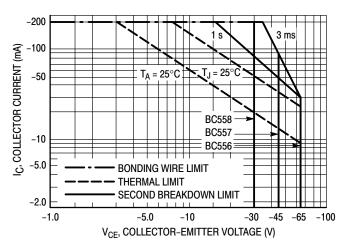


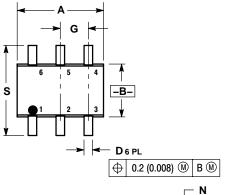
Figure 14. Active Region Safe Operating Area

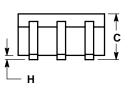
The safe operating area curves indicate  $I_C$ – $V_{CE}$  limits of the transistor that must be observed for reliable operation. Collector load lines for specific circuits must fall below the limits indicated by the applicable curve.

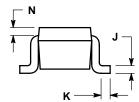
The data of Figure 14 is based upon  $T_{J(pk)} = 150^{\circ}C$ ;  $T_{C}$  or  $T_{A}$  is variable depending upon conditions. Pulse curves are valid for duty cycles to 10% provided  $T_{J(pk)} \leq 150^{\circ}C$ .  $T_{J(pk)}$  may be calculated from the data in Figure 13. At high case or ambient temperatures, thermal limitations will reduce the power that can be handled to values less than the limitations imposed by the secondary breakdown.

#### PACKAGE DIMENSIONS

SOT-363 (SC-88) CASE 419B-02 **ISSUE T** 







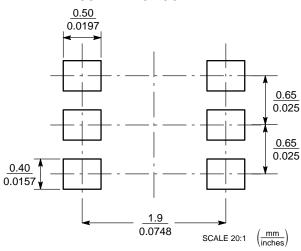
#### NOTES:

- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- CONTROLLING DIMENSION: INCH
- 3. 419B-01 OBSOLETE, NEW STANDARD 419B-02.

	INCHES		MILLIN	IETERS		
DIM	MIN	MAX	MIN	MAX		
Α	0.071	0.087	1.80	2.20		
В	0.045	0.053	1.15	1.35		
С	0.031	0.043	0.80	1.10		
D	0.004	0.012	0.10	0.30		
G	0.026 BSC		0.65	BSC		
Н		0.004		0.10		
J	0.004	0.010	0.10	0.25		
K	0.004	0.012	0.10	0.30		
N	0.008 REF		0.20	REF		
S	0.079	0.087	2.00	2 20		

- STYLE 1: PIN 1. EMITTER 2
  - 2. BASE 2 3. COLLECTOR 1
  - 4. EMITTER 1
  - 5. BASE 1
  - 6. COLLECTOR 2

#### SOLDERING FOOTPRINT\*



\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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